Specification: TS-S96D058F Date: February, 2000





Technical Specification for

Optical Transceiver Module

SCM7312-XC

155.52Mbps	622.08Mbps	other
Short Haul Intermediate Reach	Long Haul Long Reach	other
Single 5.0 V	Single 3.3 V	other
1.3 µm	1.55 µm	other
Transmitter	Receiver	Transceiver
	(2R / 3R)	(

SUMITOMO ELECTRIC

SUMITOMO Electric reserves the right to make changes in the specification described here-inafter without prior notice.

#Safety Precaution	<u>Symbols</u>	This specification uses various picture symbols to prevent possible injury to operator or other
persons or damage to properties	for appropria	ate use of the product. The symbols and definitions are as shown below. Be sure to be familiar
with these symbols before readir	ng this specific	ication.

<u>∧</u> War	ning	Wrong operation without following this instruction may lead to human death or serious injury.
▲ Car	ution	Wrong operation without following this instruction may lead to human injury or property damage.

Example of picture symbols

indicates prohibition of actions. Action details are explained nearby.

indicates compulsory actions or instructions. Action details are explained near by.

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1. General

SCM7312-XC is a series of compact and high speed performance digital optical transceiver module ideally designed for versatile high speed network applications. 1300nm high speed InGaAsP DFB-LD and InGaAs PIN-PD are provided as a light source and a detector, respectively. Transceiver module has PC board mountable package with electrical and optical interfaces.

* Data Rate 622.08 Mbps, NRZ

* Duty Cycle 50%

* Power Supply Voltage Single +3.3V

* Electrical Interface ECL(Data, Clock), C-MOS(SD)

* Fiber Coupled Power -3 ~ +2dBm into SMF

* Input Power Range -8 ~ -28dBm

* Connector Interface SC Duplex Connector

The features of SCM7312-XC are listed below.

* Features Low Power Supply Voltage / Low Power Consumption

Plastic Molded Package Multi-sourced Footprint

Transmitter..... Uncooled Laser with Automatic Power Control IC

Optical Output Shut-down (Disable)

Laser Bias Current Monitor / Rear Facet Monitor

Class 1 Laser Product (IEC 825-1 and FDA 21 CFR 1040.10 and 1040.11)

Receiver...... Wide Dynamic Range

Built-in Clock Recovery (utilizing a SAW filter)

ITU-T G.957 / G.958 and Bellcore TA-NWT-000253 Compliant

Signal Detect (SD) Function

2. Block Diagram

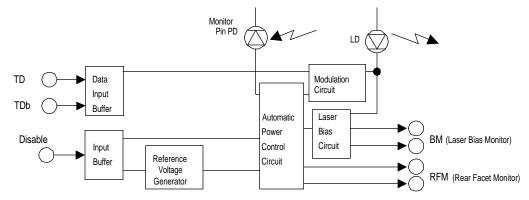


Figure 1-1. Block Diagram (Transmitter)

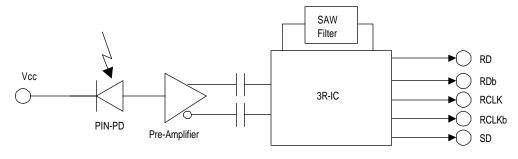


Figure 1-2 Block Diagram (Receiver)

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3. Package Dimension

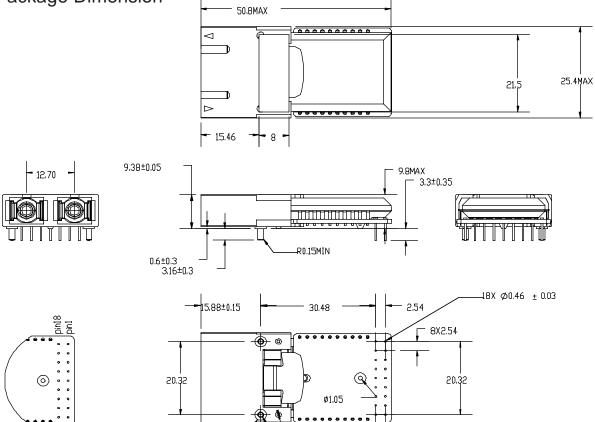


Figure 2. Package Dimension

∆ Caution

2X Ø1.5 ± 0.1

On not disassemble this product. Otherwise, failure, electrical shock overheating or fire may occur.

2X Ø3

Handle the lead pin carefully. Use assisting tools or prospective aids as required. A lead pin may injure skin or human body

4. Pin Assignment

pin10 pin9

No.	Symbol	Function
1	NC	No User Connection
2	NC	No User Connection
3	RCLKb	Differential Clock Output (Negative)
4	RCLK	Differential Clock Output (Positive)
5	BM(-)	Monitoring pin for LD Bias Monitor
6	BM(+)	Monitoring pin for LD Bias Monitor
7	Disable	LD Disable Input
8	RFM(+)	Monitoring pin for Rear Facet Monitor
9	RFM(-)	Monitoring pin for Rear Facet Monitor
10	Veetx	Power Supply (-) for Transmitter : Connected to GND
11	TD	Transmitter Differential Data (Positive)
12	TDb	Transmitter Differential Data (Negative)
13	Vcctx	Power Supply (+) for Transmitter: Connected to +3.3V
14	Vccrx	Power Supply (+) for Receiver : Connected to +3.3V
15	SD	Signal Detect (FLAG)
16	RDb	Received Differential Data (Negative)
17	RD	Received Differential Data (Positive)
18	Veerx	Power Supply (-) for Receiver : Connected to GND

NC pins should left open for additional functions in the future

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5. Absolute Maximum Ratings

Parameter	Symbol	min.	Max	Unit	Note
Storage Case Temperature	Ts	-40	85	°C	1, 2
Operating Case Teperature	Tc	0	70	°C	1, 2, 3
		-40	85	°C	1, 2, 4
Supply Voltage	Vcc-Vee	0.0	4.0	V	5
Input Voltage	Vi	Vee	Vcc+0.5	V	6
Lead Soldering (Temperature)			260	°C	7
(Time)			10	sec.	

Note 1. No condensation allowed. 2. SCM7312-XC 3. SCM7312-XC-W 4. Vcc>Vee 5. TD, TDb, Disable 6. Measured on lead pin at 2mm (0.079in.) off the package bottom

▲ Warning

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Use the product with the rated voltage described in the specification. If the voltage exceeds the maximum rating, overheating or fire may occur.

Caution

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Do not store the product in the area where temperature exceeds the maximum rating, where there is too much moisture or dampness, where there is acid gas or corrosive gas, or other extreme conditions. Otherwise, failure, overheating or fire may occur.

6. Electrical Interface

(Unless otherwise specified, Vcc-Vee = 3.14 to 3.47 V and all operating temperature shall apply.)

6-1. Transmitter side

Parameter		Symbol	min.	Тур.	Max.	Unit	Note
Supply Voltage		Vcc-Vee	3.14	3.30	3.47	V	
Supply Current		ldtx		90	150	mA	1, 2, 3
					200	mA	1, 2, 4
Input Voltage	High	Vih	Vcc-1.17		Vcc-0.73	V	5, 6
TD, TDb	Low	Vil	Vcc-1.95		Vcc-1.45		
Input Current	High	lih	-10		150	μΑ	5, 6
TD, TDb	Low	lil	-10		10		
Signal Input Rise / Fall T	ime				1.5	nsec.	7
Disable Input Voltage		Vdi	Vee+2.0		Vcc	V	8
Disable Input Current		ldi	-10		200	μΑ	8
LD Bias Monitor Voltage		Vbm	0.01		0.50	V	5, 9
Rear Facet Monitor Volta	age	Vrfm	0.01		0.20	V	2, 9

Note 1. Output current is not included. 2. Measured at the bit rate of 622.08Mbps, 50% duty cycle data, 3.SCM7312-XC(Tc=0~70°C) 4.SCM7312-XC-W(Tc=-40~85°C)

^{9.} The Laser Bias and Rear Facet Monitor currents are calculated as raitos of the corresonding voltages across the current-sensing resistors, 10Ω and 200Ω , respectively(refer to Figure 3). Upon mesureing or utilizing these values, use a device whose input impedance is high enough(> $1M\Omega$) compared with those resistors.

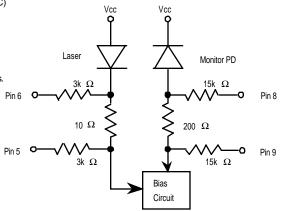


Figure 3 Monitor Circuit Schematic Diagram

^{5.} Vcc=+3.3V, 6.Tc=25°C, 7. 20 ~ 80%, 8. The transmitter is enable as default state and requires an external voltage only to disable.

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6-2. Receiver side

Parameter		Symbol	min.	Тур.	Max.	Unit	Note
Supply Voltage		Vcc-Vee	3.14	3.30	3.47	V	
Supply Current		Idrx		115	160	mA	1,2
					180	mA	1,3
Data & Clock	High	Voh	Vcc-1.10		Vcc-0.86	V	4
Output Voltage	Low	Vol	Vcc-1.86		Vcc-1.50		
SD	High	Voh	2.40		Vcc	V	4,6
Output Voltage	Low	Vol	0.00		0.40		4,7
Clock Rise / Fall Time		Trc / Tfc			700	psec.	8,9
Data Rise / Fall Time		Trd / Tfd			1000	psec.	8,9
Clock Sampling Point		Tcsp	0.6	0.7	0.8	nsec	10

Note 1. Output current is not included. 2. SCM7312-XC (Tc=0 ~ 70°C), 3. SCM7312-XC-W (Tc=-40 ~ 85°C)

- 4. Vcc=+3.3V, Tc=25°C
- 5. Termination condition : RI= 50Ω to Vccrx -2V
- 6. Output current Ioh =-200μA
- 7. Output current IoI = 2.1mA
- 8.20~80%
- 9. Input capacitance and stray capacitance of measuring devices should be less than 2pF 10. Phase difference between cross point of RD and rising edge of RCLK. (Please refer to Figure 4)

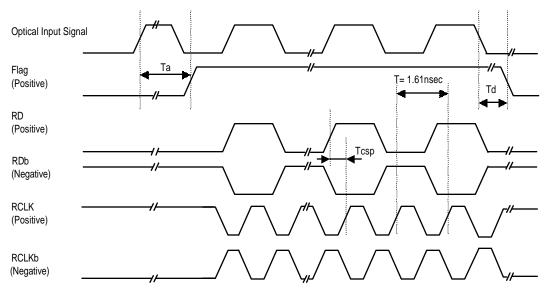


Figure 4. Timing Chart

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7. Optical Interface

(Unless otherwise specified, Vcc-Vee = 3.14 to 3.47 V and all operating temperature shall apply.)

7-1. Transmitter side

Parameter	Symbol	min.	Тур.	Max.	Unit	Note	
Average Output Power	Po	-3.0		2.0	dBm	1	
Extinction Ratio	Er	10.0			dB	1	
Center Wavelength	λς	1280		1335	nm		
Spectral Width (-20dB Width)	Δλ			1.0	nm		
Side Mode Suppression Raito	Sr	30.0			dB		
Eye Mask for Optical Output	С	Compliant with ITU-T recommendation G.957					

Note 1. Measured at 622.08Mbps PRBS2^23-1, 50% duty cycle data

Relation between Input Signal

and Optical Output Signal

Input	Signal	Optical Output Siganl
TD	TDb	
High	Low	ON (High)
Low	High	OFF (Low)
High	High	Undefined
Low	Low	Undefined

Marning

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Do not look at the laser beam projection area (e.g. end of optical connector) with naked eyes or through optical equipment while the power is supplied to this product. Otherwise, your eyes may be injured.

7-2. Receiver side

Parameter	Symbol	min.	Тур.	Max.	Unit	Note
Bit Rate Range	-	6	322.08 +/- 50pp	m	Mbps	
Minimum Sensitivity	Pmin		-33.0	-28.0	dBm	1, 2
Overload	Pmax	-8.0			dBm	1, 2
Clock Jitter(rms)	Tjc			16.0	psec	2, 3, 4
Clock Duty	Cduty	45.0	50.0	55.0	%	2, 3, 4
Data Jitter(rms)	Tjd			40.0	psec	2, 3, 4
Consecutive Identical Digit	CID	72	100		bits	3
SD Assert Level	Pa	-50	-36.5	-28	dBm	2
SD deassert Level	Pd	-50	-37.5	-28	dBm	
SD Assert Time	Та			1000	μsec	2, 3, 6
SD deassert Time	Td			100	μsec	

Note 1. BER=10^-10

- 2. Measured at the bit rate of 622.08Mbps, PRBS 2^23-1, NRZ
- 3. Optical Input Power: -28.0 \sim -8.0dBm,
- 4.Terminated condition for RD, RDb, RCLK and RCLKb : RI=50 Ω to Vccrx-2V.
- 5.Duty 50% input signal
- 6. Refer to Figure 4

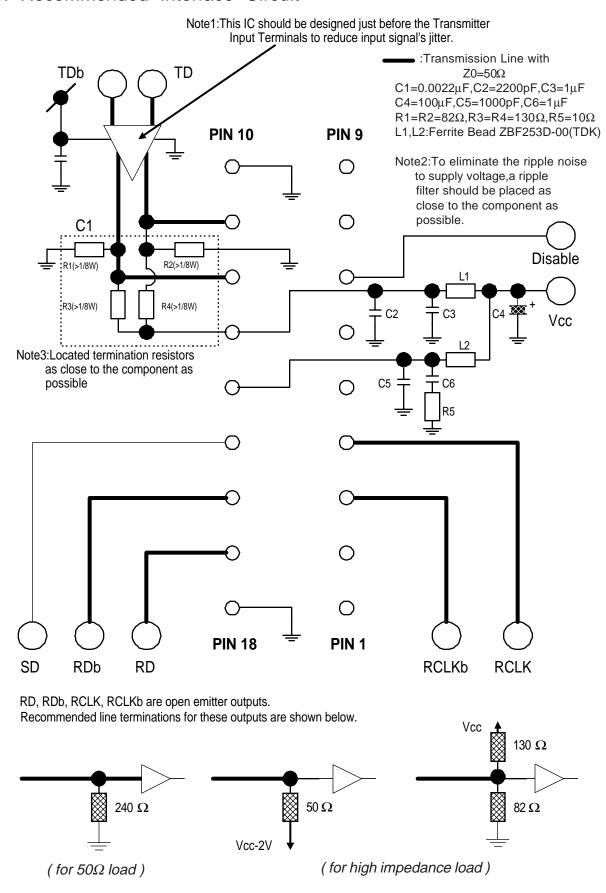
8. Relation between Disable Input Voltage and Optical Output Power

Disable Input Voltage	Optical Output Power				
"L" (0[v] ~ 0.8[v])	Enabled				
"H" (2.0[v] ~ VCCTX)	Disabled (<-45dBm)				

Note. Enabled for no Disable input (pin 7 opened)

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9. Recommended Interface Circuit



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10. Reliability Test

GR-468-CORE Issue 1, December 1998 Laser Module

HEADING	HEADING TEST REFEREI		CONDITIONS	SAM	1PLIN	G	ENV'T		Sumitomo Result	
				LTPD	SS	С	СО	RT/ UNC	SS	Pass/Fail
	Mechanical	MIL-STD-883	5 times/axis							
	Shock	Method 2002	with TEC 500 G, 1.0ms	20	11	0	R	R		
			w/o TEC 1,500G, 0.5ms	20	11	0	R	R	11	Pass
	Vibration	MIL-STD-883	Cond. A 20G, 20-2,000G	20	11	0	R	R	11	Pass
Mechanical		Method 2007	Hz, 4min/cy, 4cy/axis							
Integrity	Thermal Shock	MIL-STD-883	Delta T=100degC	20	11	0	R	R	11	Pass
		Method 1011	0degC to 100degC							
	Solderability	MIL-STD-883	(steam aging not	20	11	0	R	R	11	Pass
		Method 2003	required)							
	Fiber Pull		1 kg; 3 times; 5 sec	20	11	0	R	R		
			2 kg; 3 times; 5 sec	20	11	0	-	0	11	Pass
	Accel. Aging	(R)-4-53 Section	70degC; rated power							
	(High Temp.)	5.18	2,000 hrs.	-	10	-	R	-		
			5,000 hrs.			-	0	-		
			85degC; rated power			-				
			2,000 hrs.	-	25		-	R	25	Pass
			5,000 hrs.		10			0	25	Pass
Endurance	High Temp.	-	max. storage T	20	11	0	R	R		
	Storage		2,000 hrs.							
	Low Temp.	-	min, storage T	20	11	0	0	0	11	Pass
	Storage		2,000 hrs.							
	Temperature	Section 5.20	-40degC to +70degC							
	Cycling		100 pass/fail	20	11	0	R	-		
			500 for info.	-	11	-	R	-		
			-40degC to +85degC							
			500 pass/fail	20	11	0	-	R	11	Pass
			1,000 for info.	-	11	-	-	R	11	Pass
	Damp Heat	MIL-STD-202	85degC/85%RH 1,000hrs.	20	11	0	R	R	11	Pass
		Method 103 or	or 50degC/85%RH, 3,500							
		IEC-68-2-3	hrs.							
	Cyc. Moist,. Res.	Sec. 5.23	=	20	11	0	_	R	11	Pass
Special Tests	Internal	MIL-STD-883	Max. 5,000ppm water	20	11	0	R	R	11	Pass
	Moisture	Method 1018	vapour							
	ESD Threshold	Section 5.22		-	6	-	R	R	6	

LTPD (in %); min. acceptable sample size(SS) and corresponding number of allowed failures (C)

CO; Conditional Objective

RT/UNC; Room Temp. / Uncontrol

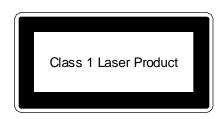
R; Requirement

O; Objective

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11. Laser Safety

This product uses a semiconductor laser system and is a laser class 1 product acc. FDA, complies with 21CFR 1040. 10 and 1040.11. Also this product is a laser class 1 product acc. IEC 60825-1.



12. Other Precaution

Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed.

The governmental approval is required to export this product to other countries. To dispose of these components, the appropriate procedure should be taken to prevent illegal exportation.

This module must be handled, used and disposed of according to your company's safe working practice.



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Be sure to carry out correct soldering for connection to peripheral circuits in order to prevent contact failure or short-circuit. Otherwise, a strong laser beam may cause eye injury, overheating or fire.

Do not put this product or components of this product into your mouth. This product contains material harmful to health.



Be sure to turn the power off when you touch this product connected to the printed circuit boards. Otherwise, electric shock may occur.

Dispose this product or equipment including this product properly as an industrial waste according to the regulations.

13. Ordering Information

Ordering Number	Connector type	Operating Temperature
SCM7312-XC	SC Duplex Connector	0 ~ 70°C
SCM7312-XC-W	SC Duplex Connector	-40 ~ 85°C

14. For More Information

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